

Title (en)

METHOD AND DEVICE FOR PERFORATING MATERIAL BANDS

Title (de)

VERFAHREN UND VORRICHTUNG ZUR PERFORATION VON MATERIALBAHNEN

Title (fr)

PROCEDE ET DISPOSITIF DE PERFORATION DE BANDES DE MATIERE

Publication

**EP 1105333 A1 20010613 (DE)**

Application

**EP 99940143 A 19990804**

Priority

- DE 19931917 A 19990708
- EP 9905645 W 19990804
- FR 9810502 A 19980818

Abstract (en)

[origin: WO0010899A1] The invention relates to a method and device for forming folds (13, 24) on specimens (20) which are separated from a material strip (1) with several possible layers. Two cutting or perforating and cutting units (14, 16) are placed one after the other in the direction (8) of displacement of said strip. The material strip (1) is cut by means of a cutting unit (14) associated with the first longitudinal fold (13) in this area of the unit. Another perforating/cutting unit (16) perforates or cuts the material strip (1) in the area of a longitudinal fold (24), whereby bridges of said material are produced. At least one of the cutting or perforating tools (34, 38) can be adjusted in relation to the material strip (1).

IPC 1-7

**B65H 45/28**

IPC 8 full level

**B65H 45/16** (2006.01); **B65H 45/28** (2006.01)

CPC (source: EP US)

**B65H 45/28** (2013.01 - EP US)

Citation (search report)

See references of WO 0010899A1

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

**WO 0010899 A1 20000302**; AT E219466 T1 20020715; CN 1235786 C 20060111; CN 1319068 A 20011024; DE 59901819 D1 20020725; EP 1105333 A1 20010613; EP 1105333 B1 20020619; HK 1040687 A1 20020621; HK 1040687 B 20060728; JP 2002523319 A 20020730; US 2001019989 A1 20010906; US 6454692 B2 20020924

DOCDB simple family (application)

**EP 9905645 W 19990804**; AT 99940143 T 19990804; CN 99811126 A 19990804; DE 59901819 T 19990804; EP 99940143 A 19990804; HK 02102190 A 20020322; JP 2000566179 A 19990804; US 78979201 A 20010220